

RX Family

R01AN4359EJ0100

Rev.1.00

RX DSP Library Version 5.0

Jan 21, 2019

Introduction

This document provides an overview of the RX DSP Library Version 5.0 and the sample project using RX DSP Library Version 5.0 on e²studio and CS+.

Target Device

RX Family

Contents

1. Overview of RX DSP Library	2
1.1 Structure of the Application Note	2
2. Sample Project	4
2.1 Operation Confirmation Conditions	4
2.2 Sample Source Files	5
2.3 Build Configuration	5
3. Procedure to Execute the Sample Project	6
3.1 e ² studio.....	6
3.1.1 Import.....	6
3.1.2 Build	7
3.1.3 Execute	7
3.2 CS+	9
3.2.1 Import.....	9
3.2.2 Build	10
3.2.3 Execute	11

1. Overview of RX DSP Library

The RX DSP library Version 5.0 contains the following 5 APIs:

1. Statistical Operation API
2. Filter Operation API
3. Linear Transform API
4. Complex Number Operation API
5. Matrix Operation API

The APIs provide efficient operations using the RX CPU's floating-point and DSP instructions.

1.1 Structure of the Application Note

As shown in Table 1-1, the RX DSP Library Version 5.0 consists of several documents, library files and sample projects. The library files are optimized for each RXv1, RXv2 and RXv3 CPU and the sample projects are configured for each CPU.

Table 1-1 Structure of DSP Library

Folder	File	Descriptions
an-r01an4359ej0100-rx-dsplib	r01an4359ej0100-rx-dsplib.pdf	This application note
reference_document	r01tu0012ej0100-rx-dsplib.pdf	Release note
	r01uw0200ej0100-rx-dsplib.pdf	User's Manual of RX DSP Library APIs
	r01an4360ej0100-rx-dsplib.pdf	Information of RXv1 DSP library such as execution cycle count
	r01an4361ej0100-rxv2-dsplib.pdf	Information of RXv2 DSP library such as execution cycle count
	r01an4362ej0100-rxv3-dsplib.pdf	Information of RXv3 DSP library such as execution cycle count
dsplib-rxv1	RX_DSP_*.lib r_dsp_*.h	Library and header files for RXv1 DSP library
dsplib-rxv2	RX_DSP_*.lib r_dsp_*.h	Library and header files for RXv2 DSP library
dsplib-rxv3	RX_DSP_*.lib r_dsp_*.h	Library and header files for RXv3 DSP library
RXv1_DSP_Sample_CCRX	Sample project files for RXv1	Sample project (MCU: RX631)
RXv2_DSP_Sample_CCRX	Sample project files for RXv2	Sample project (MCU: RX64M)
RXv3_DSP_Sample_CCRX	Sample project files for RXv3	Sample project (MCU: RX66T)

There are eight types of library files and eight header files in each CPU's "dsplib-rxv*" folder.

As shown in Table 1-2, the library files are classified according to the supported FPU, endian modes, and error checking. As shown in Table 1-3, the header files are categorized into definitions for API exclusive and common. All common definitions are described in r_dsp_types.h, which is included in each API header file. Refer to "RX DSP Library APIs Version 5.0 User's Manual: Software (R01UW0200)" for detailed information.

Table 1-2 List of DSP Library files

FPU	Endian	Error checking	Library file name
available	Little-endian	unavailable	RX_DSP_NOFPU_LE.lib
		available	RX_DSP_NOFPU_LE_Check.lib
	Big-endian	unavailable	RX_DSP_NOFPU_BE.lib
		available	RX_DSP_NOFPU_BE_Check.lib
unavailable	Little-endian	unavailable	RX_DSP_FPU_LE.lib
		available	RX_DSP_FPU_LE_Check.lib
	Big-endian	unavailable	RX_DSP_FPU_BE.lib
		available	RX_DSP_FPU_BE_Check.lib

NOTE: In case of using the floating-point Linear Transform API and/or Complex Number Operation API in the DSP Library supporting the FPU, "mathf.h" of the standard library is necessary.

Table 1-3 List of DSP Library's header files

Header file	Category	Description
r_dsp_statistical.h	API exclusive	Definitions for Statistical Function API
r_dsp_filters.h		Definitions for Filter Function API
r_dsp_transform.h		Definitions for Linear Transform Function API
r_dsp_complex.h		Definitions for Complex Function API
r_dsp_matrix.h		Definitions for Matrix Function API
r_dsp_types.h	Common	Definitions for structures, error codes and options
r_dsp_ver_info.h		Common definitions for all APIs
r_dsp_typedefs.h		Data type definitions for DSP Library

2. Sample Project

The sample projects provide examples of usage of the RX DSP Library.

The RX DSP Library contains sample projects for the RXv1, RXv2 and RXv3 CPUs. This section explains the sample project for RXv3 as an example.

2.1 Operation Confirmation Conditions

Table 2-1 shows the operation confirmation conditions of the sample project.

Table 2-1 Operation Confirmation Conditions

Item	Description
IDE	Renesas Electronics e ² studio V7.2.0 Renesas Electronics CS+ for CC V8.00.00
C/C++ Compiler	Renesas Electronics RX Compiler CC-RX V3.00.00

2.2 Sample Source Files

Table 2-2 shows the sample source files in the sample project.

Table 2-2 List of sample source files

Source file	Description
sample_dsp_main.c	main program of the sample project
sample_dsp_realFFT.c	example to use the floating-point real FFT API
sample_dsp_complexFFT.c	example to use the complex FFT API
sample_dsp_fir.c	example to use the Generic FIR Filter API
sample_dsp_iirbiquad.c	example to use the IIR Biquad Filter API
sample_dsp_iirsinglepole.c	example to use the single-pole IIR Filter API
sample_dsp_iir.c	example to use the Generic IIR Filter API
rFFT_in256_f32.h	input data for floating-point real FFT
windowCoefficient_f32.h	window function coefficients for real FFT
cFFT_in64_i16.h	input data for complex FFT

NOTE: "sample_dsp_realFFT.c" is effective only when the build configuration supports an FPU.

2.3 Build Configuration

As shown in Table 2-3, the sample project has eight build configurations. The build configurations consist of with/without FPU, endian and with/without error checking according to each library file.

Table 2-3 List of Debug Configuration corresponding to Library File

Build Configuration	FPU	Endian	Error Checking	Library File
RXV3_DSP_NOFPU_LE	unavailable	Little-endian	unavailable	RX_DSP_NOFPU_LE.lib
RXV3_DSP_NOFPU_LE_Check			available	RX_DSP_NOFPU_LE_Check.lib
RXV3_DSP_NOFPU_BE		Big-endian	unavailable	RX_DSP_NOFPU_BE.lib
RXV3_DSP_NOFPU_BE_Check			available	RX_DSP_NOFPU_BE_Check.lib
RXV3_DSP_FPU_LE	available	Little-endian	unavailable	RX_DSP_FPU_LE.lib
RXV3_DSP_FPU_LE_Check			available	RX_DSP_FPU_LE_Check.lib
RXV3_DSP_FPU_BE		Big-endian	unavailable	RX_DSP_FPU_BE.lib
RXV3_DSP_FPU_BE_Check			available	RX_DSP_FPU_BE_Check.lib

3. Procedure to Execute the Sample Project

The following describes the steps to build and execute the sample project on each IDE.

3.1 e² studio

This section describes how to use the sample project with e² studio V7.2.0.

3.1.1 Import

Figure 3-1 shows the procedure to import the sample project into e² studio workspace.

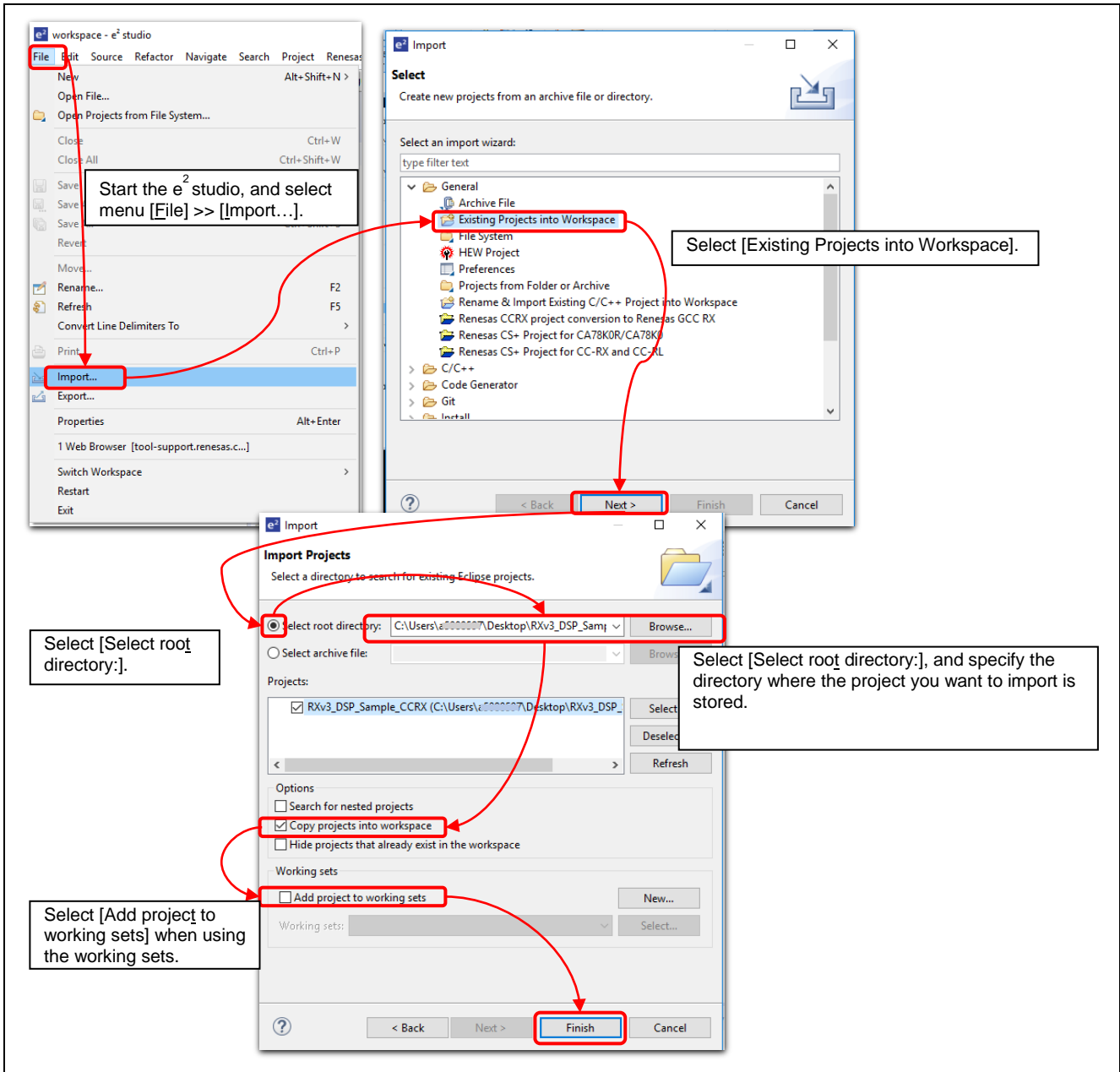


Figure 3-1 Importing a Project into e² studio

3.1.2 Build

- As shown in Figure 3-2, click the “RXv3_DSP_Sample_CCRX” project in Project Explorer, then from the menu select “Project” > “Build Configuration” > “Set Active” to select the desired build configuration. As shown in Table 2-3, there are eight build configurations. (Example: “RXV3_DSP_FPU_LE_Check” is selected.)
- Build the sample project. Click the “RXv3_DSP_Sample_CCRX” project in Project Explorer and then from the menu select “Project” > “Build Project”.

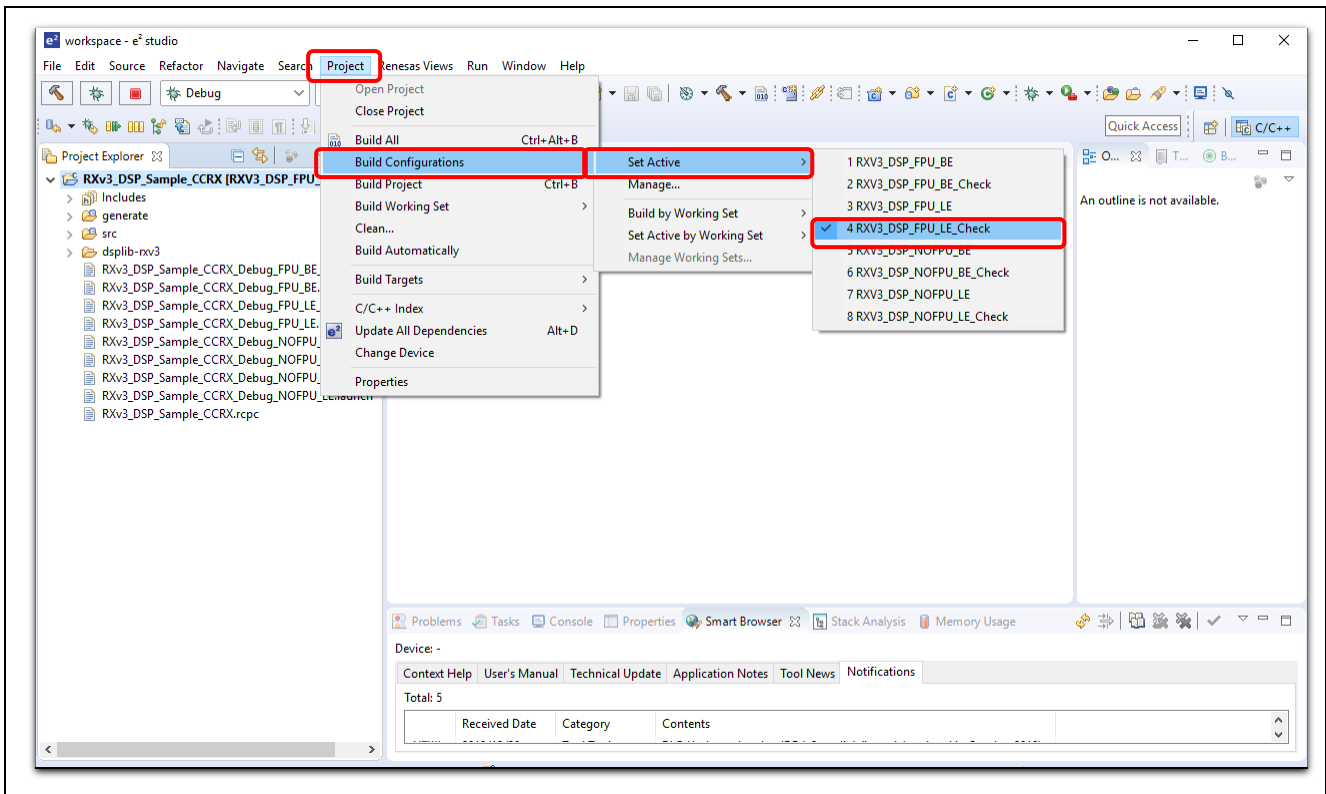


Figure 3-2 Selecting the build configuration in e² studio

3.1.3 Execute

As shown in Table 3-1, the sample project has eight debug launchers. Execute the sample program in RX simulator with the debug launcher that corresponds to the build configuration.

- Right click the debug launcher that corresponds to the selected build configuration and then select the desired debug launcher from the “Debug As” pop-up menu. (Example: “RXv3_DSP_Sample_CCRX_FPU_LE_Check” is selected.) In the “Confirm Perspective Switch” dialog box, click “Yes”. e² studio switches to Debug Perspective.
- Select “Run” > “Resume” from the menu to execute the program. For details of Debug Perspective, refer to the e² studio help at “e² studio Users Guide” > “General” > “Tutorial” > “Renesas CC-RX Tutorial”.

Table 3-1 List of Debug Launcher corresponding to Build Configuration

Build Configuration	Debug Launcher
RXV3_DSP_FPU_LE	RXv3_DSP_Sample_CCRX_Debug_FPU_LE.launch
RXV3_DSP_FPU_LE_Check	RXv3_DSP_Sample_CCRX_Debug_FPU_LE_Check.launch
RXV3_DSP_FPU_BE	RXv3_DSP_Sample_CCRX_Debug_FPU_BE.launch
RXV3_DSP_FPU_BE_Check	RXv3_DSP_Sample_CCRX_Debug_FPU_BE_Check.launch
RXV3_DSP_NOFPU_LE	RXv3_DSP_Sample_CCRX_Debug_NOFPU_LE.launch
RXV3_DSP_NOFPU_LE_Check	RXv3_DSP_Sample_CCRX_Debug_NOFPU_LE_Check.launch
RXV3_DSP_NOFPU_BE	RXv3_DSP_Sample_CCRX_Debug_NOFPU_BE.launch
RXV3_DSP_NOFPU_BE_Check	RXv3_DSP_Sample_CCRX_Debug_NOFPU_BE_Check.launch

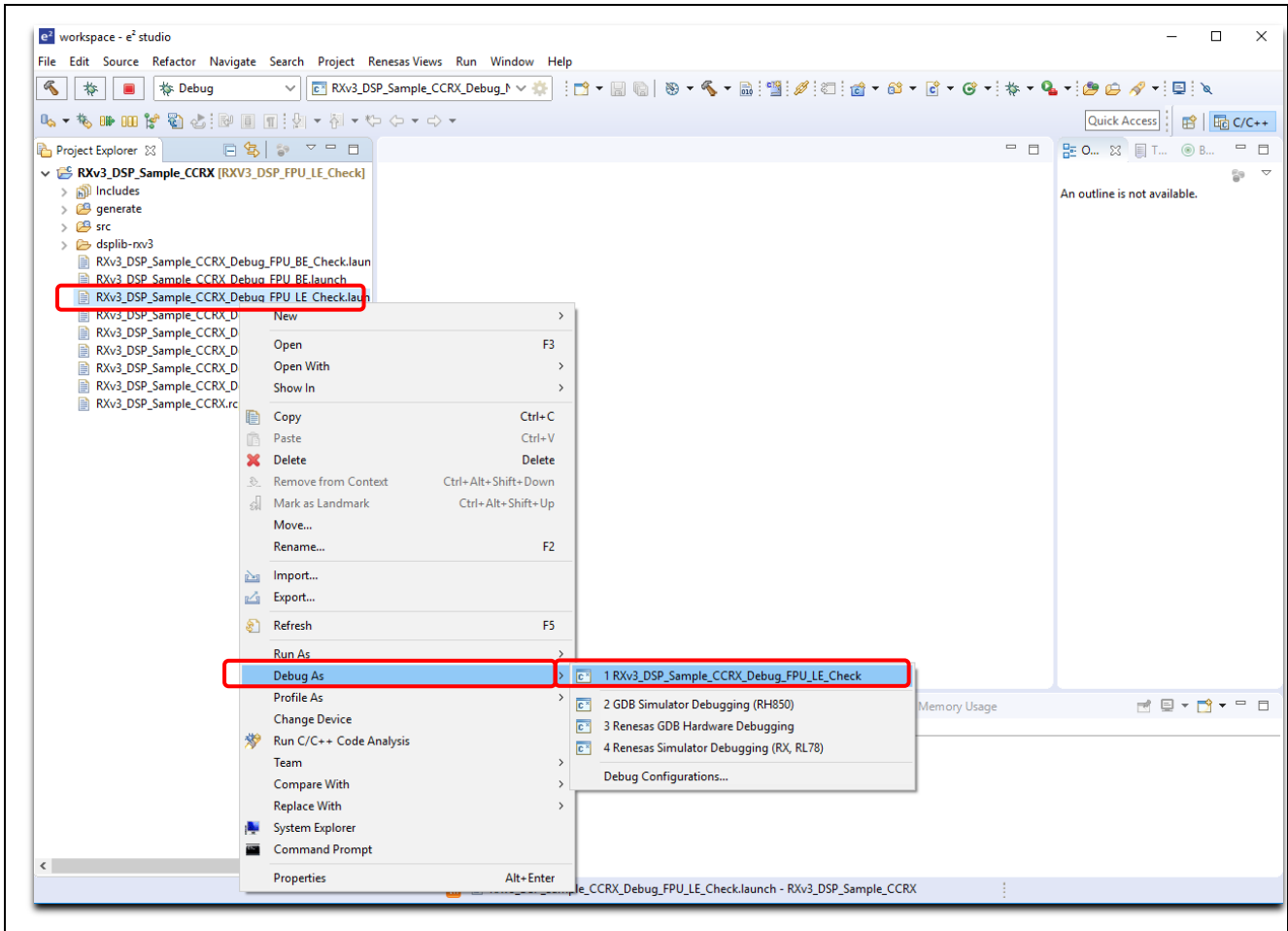


Figure 3-3 Launching a Debug Perspective

3.2 CS+

This section describes how to use CS+ V8.00.00.

3.2.1 Import

Figure 3-1 shows the procedure to import a sample project into CS+.

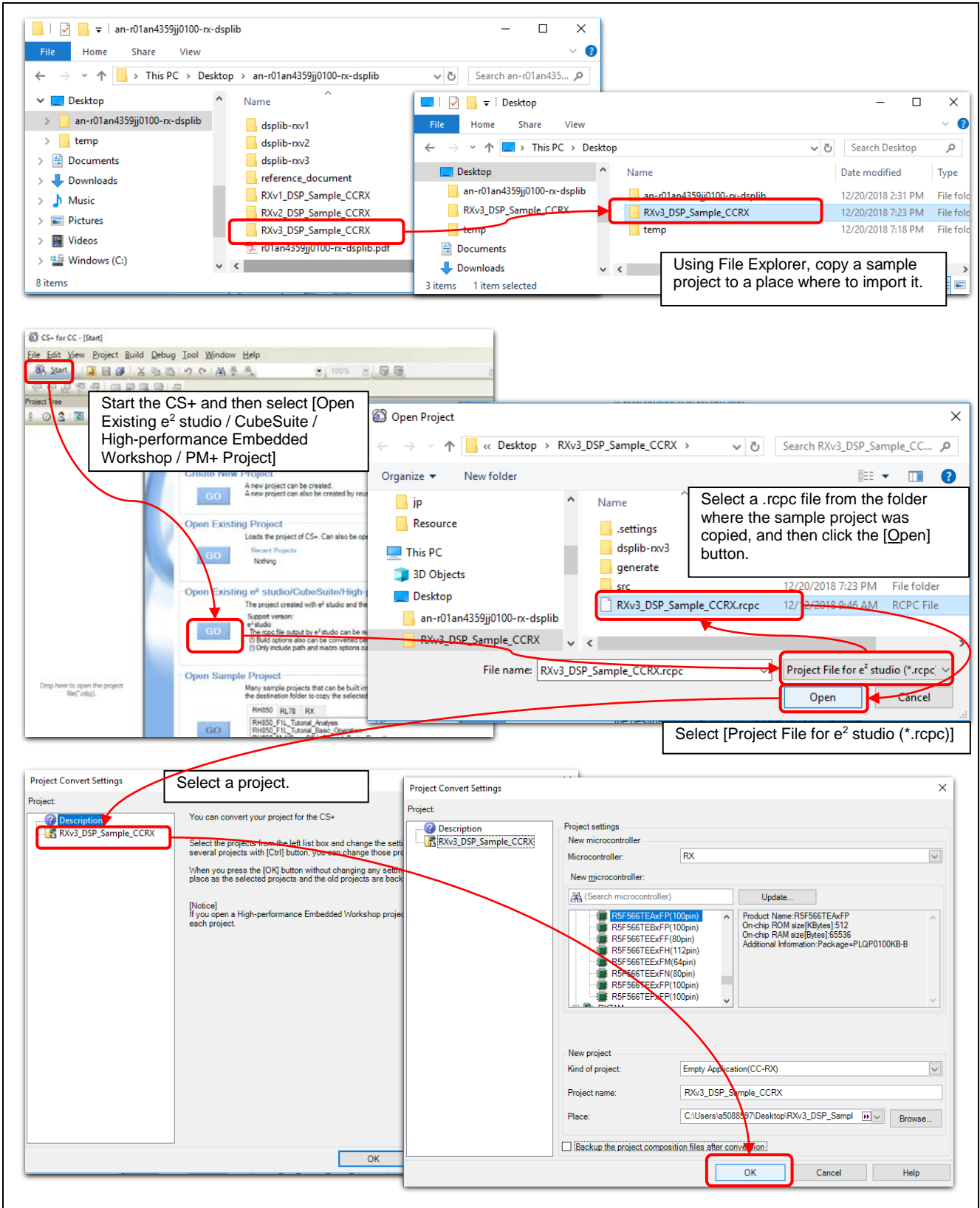


Figure 3-4 Importing a project into CS+

3.2.2 Build

1. In the Project Tree, click “CC-RX (Build Tool)”, then using the Common Options tab select Build Mode under CC-RX Property.
As shown in Table 2-3, there are eight build configurations.
(Example: “RXV3_DSP_FPU_LE_Check” is selected.)
2. To build the sample project, select “Build” > “Build Project” from the menu.

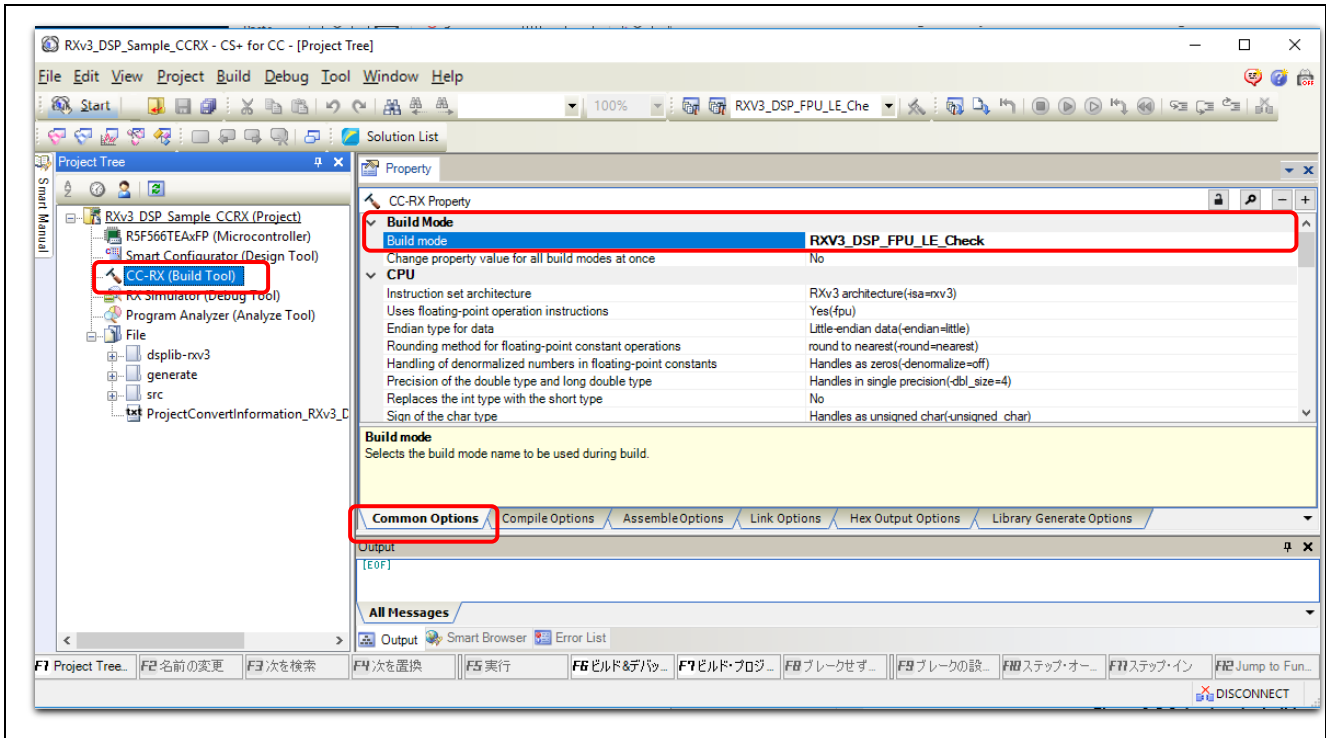


Figure 3-5 Selecting the build mode in CS+

3.2.3 Execute

Execute the sample program in RX Simulator. Before executing the program, set endian depending on the selected build configuration.

1. Select endian depending on the selected build configuration. As shown in Figure 3-6, click “RX Simulator (Debug Tool)”, then under RX Simulator Property select the Connect Settings tab and under Endian select “Endian of CPU”.
For example, since the build configuration is “RXV3_FPU_LE_Check”, select endian “Little-endian data”.
2. Select “Debug” > “Download” from the menu to execute the program.
For details of the debug screen, refer to CS+ Help “RX [with CC-RX]” > “Debug Tool” >.

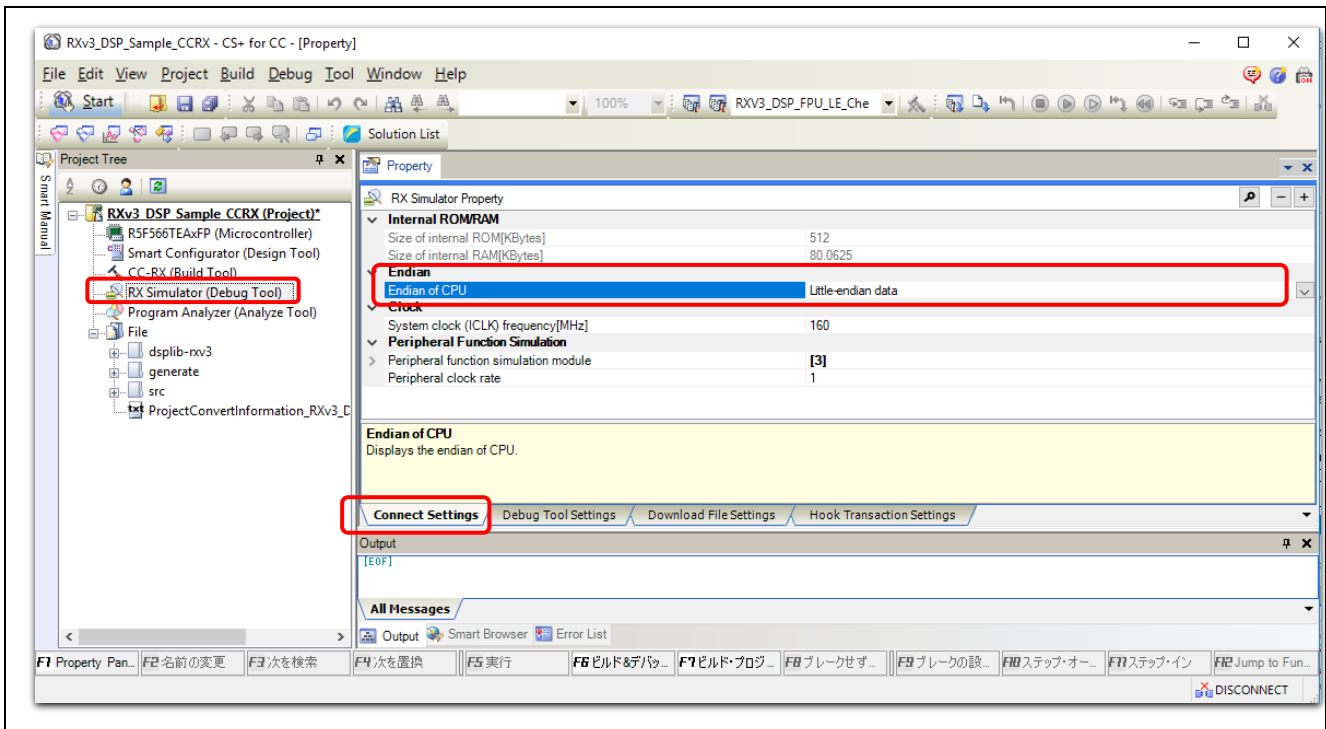


Figure 3-6 Setting of RX Simulator in CS+

Website and Support

Renesas Electronics Website

<http://www.renesas.com/>

Inquiries

<http://www.renesas.com/contact/>

All trademarks and registered trademarks are the property of their respective owners.

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Jan 21, 2019	—	First edition issued

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.
Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
6. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
11. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.
(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.4.0-1 November 2017)



SALES OFFICES

Renesas Electronics Corporation

<http://www.renesas.com>

Refer to "<http://www.renesas.com/>" for the latest and detailed information.

Renesas Electronics Corporation
TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

Renesas Electronics America Inc.
1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.
Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics Canada Limited
9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3
Tel: +1-905-237-2004

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 1709 Quantum Plaza, No.27 ZhichunLu, Haidian District, Beijing, 100191 P. R. China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, 200333 P. R. China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2265-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit 1207, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics India Pvt. Ltd.
No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India
Tel: +91-80-67208700, Fax: +91-80-67208777

Renesas Electronics Korea Co., Ltd.
17F, KAMCO Yangjae Tower, 262, Gangnam-daero, Gangnam-gu, Seoul, 06265 Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5338